Rheology of the Lower Crust: Concepts, Methods & Observations from the rock record

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Thanks :

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Rheology of the Lower Crust: Concepts, Methods, Observations

Rheology of the Lower Crust: General importance
 & Recap of Solid state deformation mechanism and flow laws

2) Quantitative Orientation Analysis: How does it work? How can it help me to understand the Lower Crust – rheology

3) Quantitative Orientation Analysis: Examples and Opportunities - Rheology and evolution of the Lower Crust

4) Rheology of the Lower Crust: Other measurements and considerations

ASK – we are all here to learn Note: Link to György HETÉNYI, Rock view <-> Geophysical view -> same/similar problems -> across scales



Modified after Huntington & Klepeis et al. 2017

Strength of the Continental Lithosphere?

What is the strength of the continental lithosphere? Why does it matter?

..knowing where the strength resides tells us fundamental things about...

how the Earth deforms, why earthquakes occur where they do, and how our planet has evolved ..(amongst other things)

Definition – **Continental lithosphere:** the continental crust and that portion of the upper mantle that behaves elastically

Deformation Behaviour of the Continental Lithosphere?

A key observation is that the pattern of deformation across the Earth appears to be different.

Plate tectonics is insufficient... on the continents?!

Deformation in the oceans seems to follow narrow bands ...but in the continents deformation is distributed over broad areas

Why? What does it depend upon?

Continuous – discontinuous deformation?







Smooth N-ward decrease in convergence *No steps across faults? continuous deformation*

Extrusion along ESE axis Increases towards ESE -> Lower (?) Crustal flow Some clear high strain zones Some distributed strain Some no strain

Crustal flow - in some parts -> What does that mean?

Back to basics: Three main types of rheological behaviour

- Elastic deformation
 - Strain disappears when force taken away
 - Rubber band, bouncing ball
- **<u>Brittle</u>** deformation (discrete)
 - Discontinuous deformation
 - Faults, earthquake
 - glass
- **Ductile** deformation
 - Flowing movement (continuous)
 - Folds
 - Toothpaste



is the study of the flow of any material under the influence of applied stress





How a rock deforms is a function of:

- Temperature ۲
- Composition ullet
- **Deformation rate** •
- Pressure •

Mars bar experiment

Silly putty experiment



Pure shear

"strength"

300 400 500 600 100 200 700 27.5MPa/km 100 **Definitions** – Strength: The total force stress 200 per unit width necessary to **Strength vs Depth Profiles:** deform a lithospheric 10 km normal 300 section (at a given strain The strength of the rate) 400 continental lithosphere depth (shear stress) can be MPa Shear stress: stress acting σ 500 plotted with respect _20 km parallel to plane of to depth (normal stress) reference 600 700 Normal stress: stress acting perpendicular to 800 plane of reference ______30 km 900 35 km 1000

MPa τ

shear stress

Strength-depth relationships are very similar regardless of rock type – for intact materials! IDEAL CRUSTAL STRENGTH – Byerlee's Law: $\tau = S_0 + \mu(\sigma_n - Pf)$



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KTB = German Continental Deep Drilling Program

SCS = Single Channel Seismic



BUT...

at higher temperatures (i.e. greater depths) rocks deform in different ways.

With increasing T the strain rate increases and rocks deform by a plastic flow law

Temperature increases with Depth: GEOTHERM IMPORTANT The basis for strength-depth profiles?





e = 10 qz 30%; fds 70% Handy et al. 1999

INTEGRATED STRENGTH PROFILE





Strength profile at KTB

25°C/km



Strength profile at KTB









 "Rheology of the Lower Crust & Upper Mantle: Evidence from Rock Mechanics, Geodesy & Field Observations"

Bürgmann and Dresen, Annual Reviews (2008)

"How weak are the continents?" Rob Butler, Geoscientist (2006)

Recap deformation mechanisms and their relationship to T, stress, strain rate?

Principles of Flow laws

Many diagrams from Passchier & Trouw 2005 & deformation microstructure course (www.microstructure.info)

Ductile Deformation – Crystal plasticity - Basics

What is needed for intracrystalline deformation?

Defects - imperfections in the structure of a crystal

0-dimensional (point),1-dimensional (dislocations)2-dimensional (boundaries)



Why are defects so important?

Intimate involvement in several grain scale processes



Deformation by movement of lattice defects

- Point defects /Vacancies
 Diffusion creep
 - Nabarro-Herring creep through
 - Cobble creep around
 - Pressure Solution
 - / Dissolution-precipitation
- Line defects
 - Dislocation glide/creep



Flow Laws





Dissolution percipitation creep – RATE CONTROL in a serial process

Dissolution-precipitation creep is a deformation mechanism that involves three serial steps.



Ions dissolve -> Diffusional transport in GB-fluid -> Ions percipitate

Therefore: Rate is controlled by the rate of one of these serial steps

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Intracrystalline plasticity – 2 main types

1. dislocation glide;

Exponential relationship between strain-rate & stress (i.e. Dorn Law):

$$\dot{\varepsilon} = \varepsilon_0 \exp\left\{-F(1 - \sigma / \sigma_p) / RT\right\}$$

strain-rate & stress subscript terms values at 0°K; F, constant.

Not considered important in most minerals due to high stresses needed at geological conditions (n.b. crystal slip not same as dislocation glide as climb also involves slip). & 2. dislocation climb (dislocation creep).

Power law relationship:

$$\varepsilon = A \exp(-Q_c / RT) \sigma^n$$

A, pre-exponential constant; Q_c , activation enthalpy for dislocation creep; n, stress exponent.

Does not include H_2O – 'dry' quartz 10x stronger than 'wet' (Si-O-Si bonds replaced by weaker Si-OH-OH-Si hydroxyl bonds – hydraulic or water weakening effect).

Constant n also depends on H_2O content.

Mean stress also omitted – increases water diffusion rates, water solubility & activation enthalpies.

Impurities may be important (e.g. in quartz) – cause considerable weakening through control of dislocation glide velocities.



How to determine A, Q, n, m? In logarithmic space: $\ln(\dot{\varepsilon}) = \ln\left(A \cdot \exp^{\left(-\frac{Q}{kT}\right)} \cdot \frac{\sigma^n}{d^m}\right)$ Experimentally $\Leftrightarrow \quad \ln(\dot{\varepsilon}) = \ln(A) - \frac{Q}{kT} + n\ln(\sigma) - m\ln(d)$

A, Q, n, m can all be determined by from

stress exponent: $\left(\frac{d\ln(\dot{\varepsilon})}{d\ln(\sigma)}\right)_{T,d} = n$ grain size exponent: $\left(\frac{d\ln(\dot{\varepsilon})}{d\ln(d)}\right)_{T,\sigma} = -m$ activation energy: $\left(\frac{d\ln(\dot{\varepsilon})}{d(1/T)}\right)_{d,\sigma} = -\frac{Q}{k}$ plots in log-log space linear fits

Experimental empirical laws

 $\dot{\epsilon} = A \exp\left\{\!\left(- \,Q + PV\right) / \,RT \right\} d^{-m} \sigma^{\alpha}$

pre-exponential constant; Q, activation energy; P, mean stress; V, activation volume (often ignored); d, grain size; σ, stress; m & n: dimensionless grain size & stress exponents.

 $m = 0, n \ge 3$ - dislocation creep;

m = 2, n = 1 - DPC1/Cobble creep;

m = 3, n = 1 - DPC1 /Nabarro-Herring creep;

m = 2-3, n = 1-3

 superplasticity/ grain boundary sliding accommodated by different mechanisms (dislocation climb (n=2)/ diffusion (n-1))

Table 9.2. Parameters for grain-size sensitive flow laws. V is molar volume, GBM is grain boundary migration.

Mineral	A,	Q, Jmol ⁻¹	n	m	Wet/	Deformation mechanism, notes	References		
	m ^m MPa s	100 5		1.07	Dry		111 11		-
Calcite	8.511 e 4	1.90 e 5	1.7	1.87	Dry	$\sigma < 25$ MPa, $2 < d < 40 \mu$ m, grain boundary sliding	1990	et	al.
Synthetic Calcite	100	1.90 e 5	3.3	1.34	Dry	$25 < \sigma < 200$ MPa, $2 < d < 40$ mm, dislocation creep	Walker 1990	et	al.
Olivine	6.079 e -13	3.00 e 5	1	2.5	Dry	Diffusion creep: $V = 6 e -6 m^3 mol^{-1}$	Karato 1993	&	Wu
Olivine	3.703 e-13	2.40 e 5	1	2.5	Wet	Diffusion creep: $V = 5 e -6 m^3 mol^{-1}$	Karato 1993	&	Wu

Table 9.3. Parameters for grain-size insensitive flow laws for minerals.

Mineral	A, $m^m MPa^{-n}s^{-1}$	Q, Jmol ⁻¹	n	Wet/ Dry	Deformation mechanism, notes	References
Calcite	1.549 e -4	3.62 e 5	11.5	Dry	σ_1 parallel to [4041], single crystal	De Bresser & Spiers 1990
Quartz	1.2 e -6	9.33 e 4	3.0		O+ orientation, single crystal, < c > slip	Linker & Kirby 1986
Quartz	6.3 e -5	2.13 e 5	5.3		\perp m orientation single crystal, < a > slip	Linker & Kirby 1986
Olivine	2.422 e 5	5.4 e 5	3.5	Dry	Dislocation creep	Karato & Wu 1993
Olivine	3.906	4.3 e 5	3.0	Wet	Dislocation creep	Karato & Wu 1993
Diopside	7.94 e -5	2.84 e 5	4.3	Dry	$\sigma < 700 \text{ MPa}$	Avé Lallement 1978
Diopside	1.58 e -8	4.42 e 5	6.5		Orientation 1	Raterron & Jaoul 1991
Diopside	3.16 e 8	7.42 e 5	8.1		Orientation 2	Raterron & Jaoul 1991
Hedenbergite	2.00 e 8	5.26 e 5	3.6	Wet		Kollé & Blacic 1983

Table 9.4. Parameters for grain-size insensitive flow laws for rocks. Asterisk indicates refitting of original data by Carter and Tsenn (1987)

Rock	Α,	Q, Jmol ⁻¹	n	Wet/	Deformation mechanism, notes	References	
	$m^m MPa^{-n}s^{-1}$			Dry			
Rocksalt	8.1 e -5	51.6 e 3	3.4	Dry	$\sigma < 10$ MPa, creep	Carter et al. 1993	
Rocksalt	1.6 e -4	68.1 e 3	5.3	Dry	$\sigma > 10$ MPa, glide	Carter et al. 1993	
Anhydrite	31.6	1.52 e 5	2		Dislocation glide	Muller & Briegel 1978	
Marble	1260	4.18 e 5	7.6		Subgrains, GBM	Schmid et al. 1980	
Marble	1.995 e 4	2.13 e 5	1.7		grain boundary sliding	Schmid et al. 1977	
Quartzite	Choose cor- rectly	1.52 e 5	2.5	Wet	Various; best estimate from av- erage values	Paterson & Luan 1990	
Quartzite	6.5 e -8	1.35 e 5	3.1	Wet	Low to moderate grade	Paterson & Luan 1990	
Granite	1.995 e -6	1.87 e 5	3.3	Dry	Semibrittle	Hansen & Carter 1983	
Granite	1.995 e -4	1.41 e 5	1.9	Wet	Semibrittle	Hansen & Carter 1983	
Albitite*	5.012 e -3	2.45 e 5	2.8	Dry	Dislocation glide, creep	Shelton et al. 1981	
Diorite	3.162 e -2	2.12 e 5	2.4	Wet	Semibrittle	Hansen and Carter 1982	
Diabase	6.310 e -2	2.76 e 5	3.1	Dry	Dislocation glide	Caristan 1982	
Websterite*	3.162 e 5	3.23 e 5	4.3	Dry	-	Avé Lallement 1978	
Websterite	1.99 e -5	3.82 e 5	5.3	Wet	High strain	Avé Lallement 1978	
Websterite	3.16 e 3	4.63 e 5	3.3	Wet	Low strain	Avé Lallement 1978	
Pyroxenite*	1.584 e -8	3.30 e 5	5.8	Dry	High T, clinopyroxenite	Kirby & Kronenburg 1984	
Pyroxenite	1.479 e 5	4.90 e 5	3.3	Wet	clinopyroxenite	Boland & Tullis 1986	
Lherzolite	4.5 e 5	5.18 e 5	4.0	Dry		Berckhemer et al. 1979	

Deformation mechanism map



Change of crossovers with grain size? — 100 micron 10 micron

Rheology derived from the outcrop/rock- microstructures. How?

Know your processes

- 1) By understanding/interpreting how a microstructure forms we can derive the conditions under which it has formed
- As grain scale processes control the macroscopic behaviour of rocks, microstructures can tell us about the processes that led to the microstructures -> flow law/rheology of a rock



Remember: Deformation by movement of lattice defects

Point defects /Vacancies

Diffusion creep

- Nabarro-Herring creep through
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But how does that look in the rock microstructure

Know your processes Dislocation creep/ Dynamic Recrystallization

Know your processes

> Analog model: Organic crystalline material

 \mathbf{C} А. в

Means, 1986

Recrystallization: change in microstructure whereby the grain configuration changes; several grain scale processes are involved Dynamic recrystallization: recrystallization occurring during deformation Annealing: recrystallization occurring without deformation - often called Static recrystallization Metadynamic recrystallization: recrystallization occurring without deformation but after deformation

Dynamic Recrystallization

General: intra and intercrystalline deformation during deformation

- 1) Shape change of grains
- 2) Subgrain Formation & Recovery
- 3) Small grains -> Rotational Recrystallization
 - 4) Small grains -> Recrystallization by nucleation
 - 5) Grain Boundary Migration
 - 6) Grain Boundary Sliding

Know your processes

1) Shape change by movement of dislocations

Observation: shape change

How?1) Prerequisite: dislocations within the crystal2) dislocation movement



Result: shape change and lattice distortion

lattice distortion/ undulose extinction



When do we get a lot of defects/dislocations in a crystal?

- High stress
- High strain rate
- low T conditions

2) Subgrain formation & Recovery

Observation: subgrains form in deformed grains

How?
1) dislocations within the crystal
2) free energy in the system is high system wants to lower its energy

How can the free energy be lowered?

Dislocations must be

A) removed or

B) organized in low energy configurations

- How is energy decreased?
 - annihiliation of dislocations

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Opposite dislocation

Annihilation



Result: less lattice distortion/ less dislocations

- Overcoming of "pile-ups" $\bot \bot \bot \bot \bot$
- Dislocation climb

B) Subgrain formation

- organization/movement of dislocations into low energy configurations



Result:



Formation of dislocation arrays / subgrain boundaries

Temperature versus Rate of Recovery





Subgrains



3 & 4) Appearance of new grains - recrystallization

Observation: appearance of new grains

How?3) RotationalRecrystallization4) Recrystallization bynucleation



3) New grains – rotational recrystallization

Observation: new grains

How? 1) dislocations within the crystal 2) Free energy in the system is high lower energy by putting more and more dislocations into the subgrain boundary Rotation of subgrain Result: subgrain grain boundary New boundary grain lower disloca -tion density



Note: Angle of Mismatch to distinguish between subgrain and grain boundary is mineral dependent $Qtz \approx 10^\circ$ Fsp $\approx 5 - 10^\circ$

3) New grains – recrystallization by nucleation

Observation: new grains

How?
1) dislocations within the crystal small cells develop
2) These cells have different amount of dislocations
rapid growth of nucleus

Result: New grain, Low dislocation density





5) Grain boundary migration

Observation: grain boundaries move/migrate

How?1) One atom from one grain moves to next grain2) Group of atoms jump from one to the next grain



Why? 1) System has high energy

system wants to lower the energy

Reasons for high energy of system?

1. High dislocation density

2. Lots of boundaries

How to lower energy?

1. Reduction of dislocation density





Result: less dislocations

In situ experiments in SEM with EBSD analysis Magnesium Alloy

Growth as energy reduction





How to lower energy?

2) Reduction the length of boundaries





Result: straight boundaries / grain size increase



Rate of migration \approx F (driving force) x M (mobility)

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Mobility \approx M_{min}^* e^{(f(T, fluid))}
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6) Grain boundary sliding

Observation: grains slide past each other in experiments

How?

- Grain boundaries "break"
- Sliding accommodated by movement of dislocation / point defects or by chemical diffusion



Try it yourself: Bath foam bubbles squeezed between finger - thumb

How can we use our knowledge to derive conditions?

Different mechanisms at different rates at different conditions

different effect on microstructural development

Rates depend on:

- 1) Stress
- 2) Strain rate / finite strain
- 3) Temperature
- 4) Fluid

Note: for dislocations to move and/or atoms to move we need T or fluid

High T

Low T

Tullis, J., Stünitz, H., Teyssier, C. and Heilbronner, R. 2000.

Thank you & Questions

100 µm

